



650V/2A N-Channel Advanced Power MOSFET

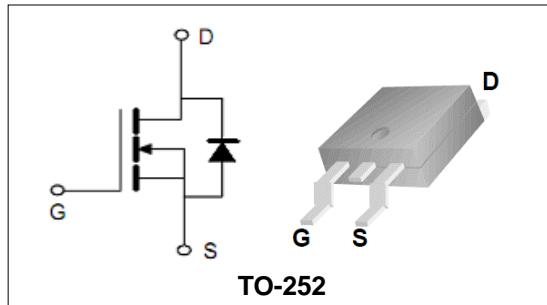
Features

- Improved dv/dt Capability, High Ruggedness.
- Maximum Junction Temperature Range (150°C)
- 100% Avalanche Tested

| | | |
|---------------|-----|---|
| BVDSS | 650 | V |
| ID | 2 | A |
| RDSON@VGS=10V | 2.9 | Ω |

Applications

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

**Order Information**

| Product | Package | Marking | Reel Size | Reel | Carton |
|---------|---------|---------|-----------|---------|----------|
| PTD2N65 | TO-252 | PTD2N65 | 13inch | 2500PCS | 50000PCS |

Absolute Maximum Ratings

| Symbol | Parameter | Rating | Unit | |
|--|----------------------------------|------------|------|---|
| Common Ratings (TC=25°C Unless Otherwise Noted) | | | | |
| V _{(BR)DSS} | Drain-Source Breakdown Voltage | 650 | V | |
| V _{GS} | Gate-Source Voltage | ±30 | V | |
| T _J | Maximum Junction Temperature | 150 | °C | |
| T _{STG} | Storage Temperature Range | -55 to 150 | °C | |
| I _S | Diode Continuous Forward Current | TC =25°C | 2 | A |

Mounted on Large Heat Sink

| | | | | |
|------------------|--|----------|------|------|
| E _{AS} | Single Pulse Avalanche Energy (Note1) | 20 | mJ | |
| I _{DM} | Pulse Drain Current Tested (Silicon Limit) (Note2) | TC =25°C | 8 | A |
| I _D | Continuous Drain current | TC =25°C | 2 | A |
| P _D | Maximum Power Dissipation | TC =25°C | 28 | W |
| R _{θJC} | Thermal Resistance Junction-to-Case (Note3) | | 4.46 | °C/W |

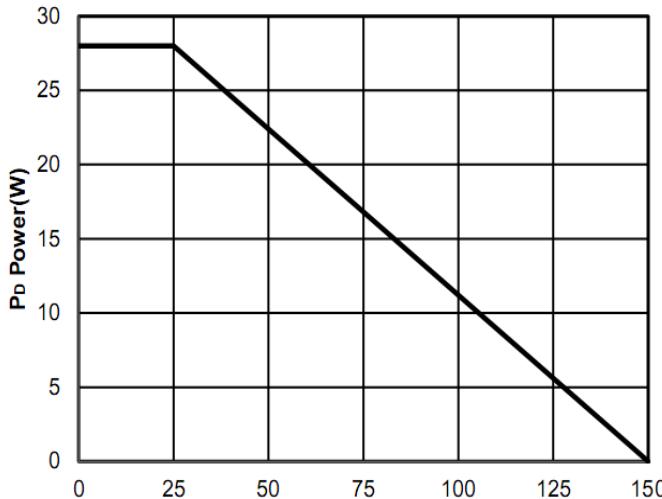
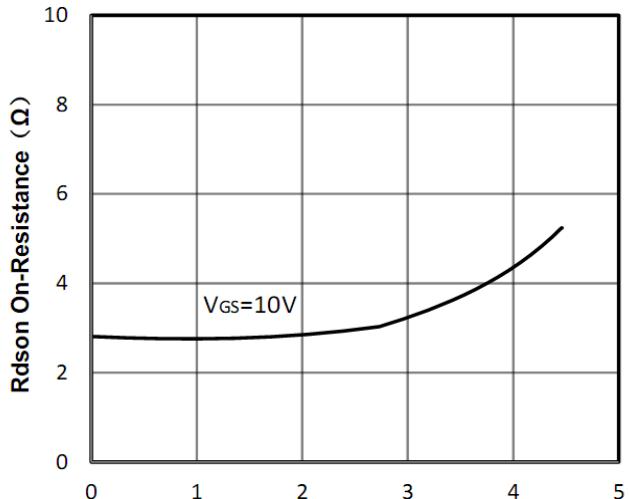
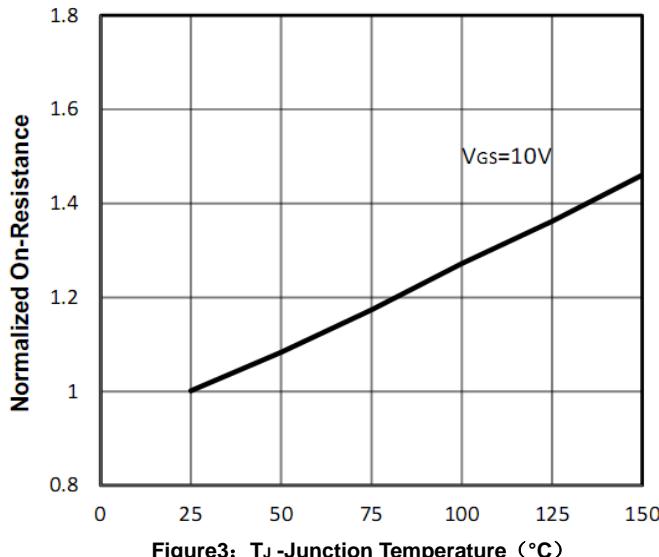
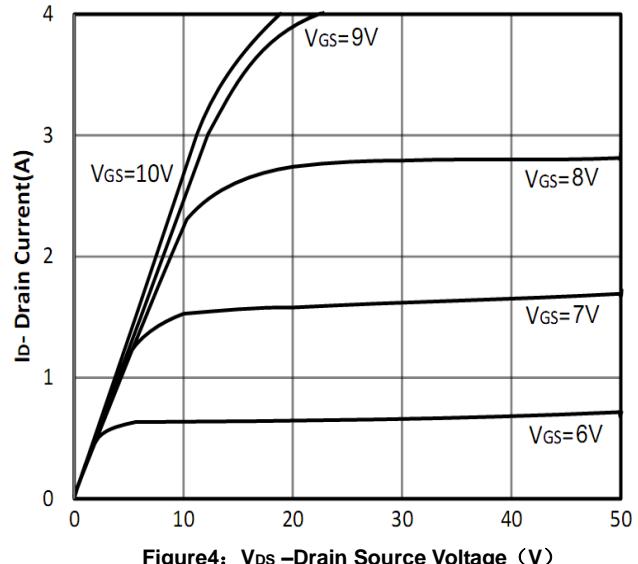
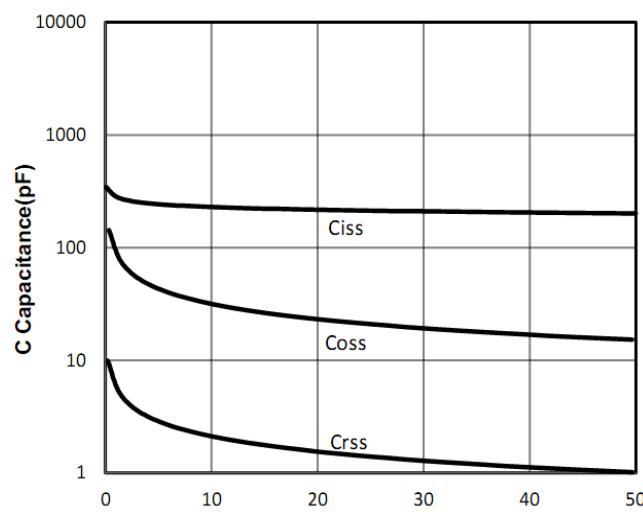
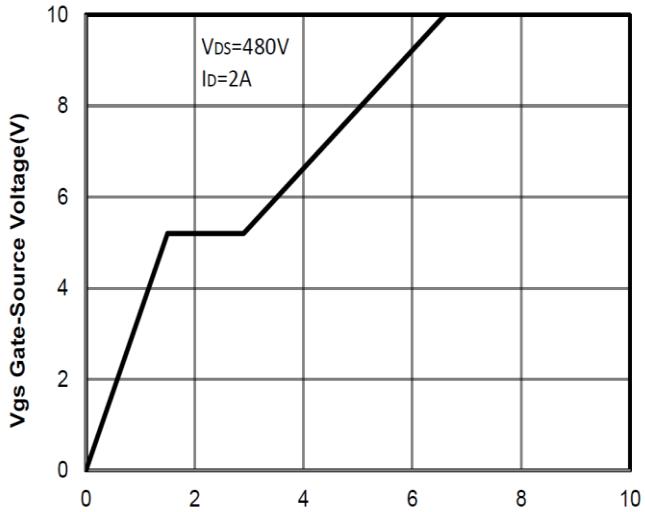


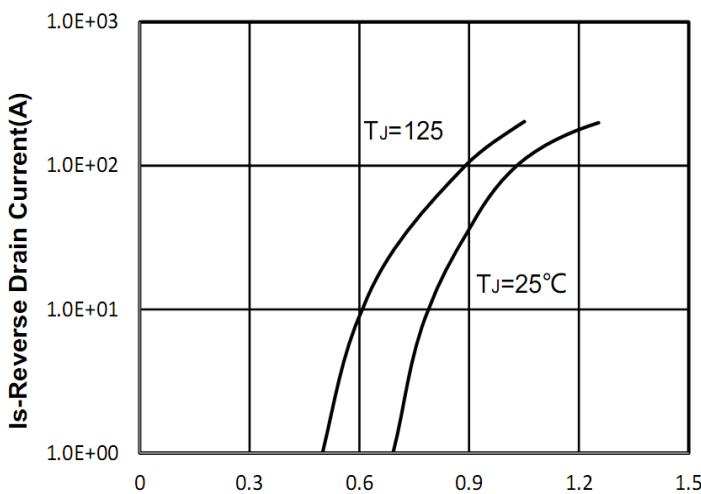
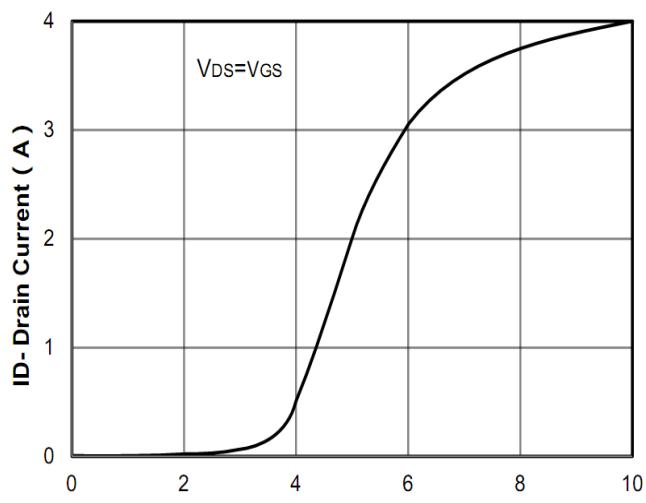
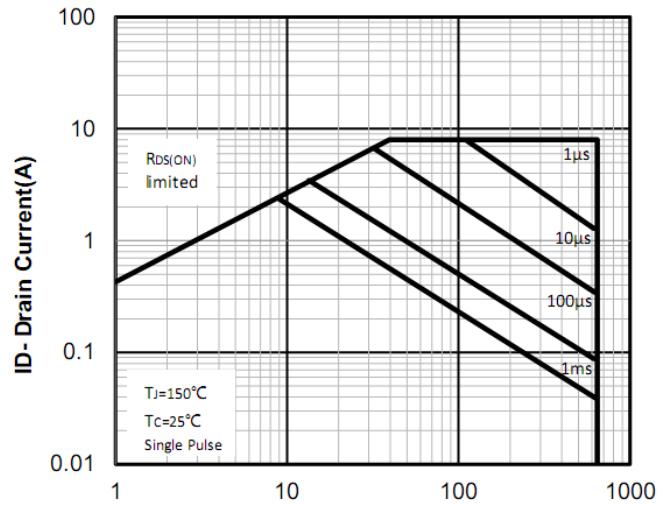
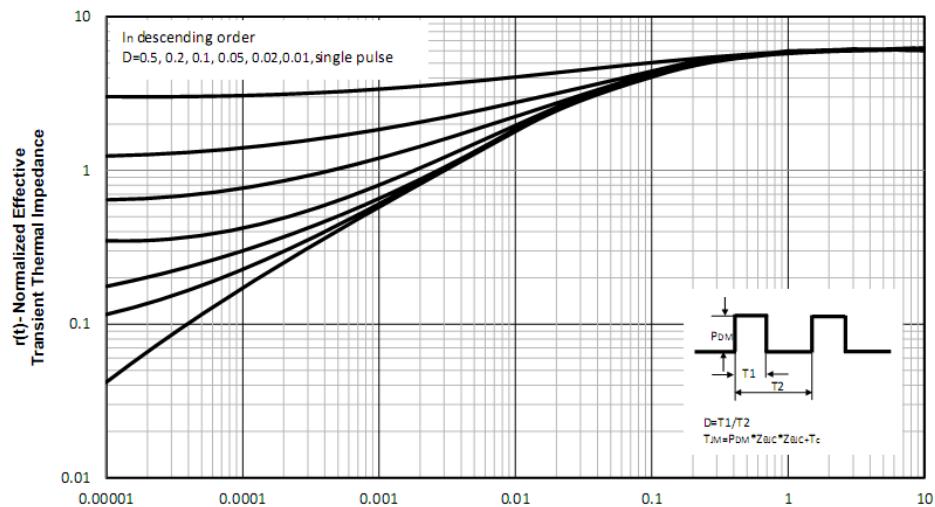
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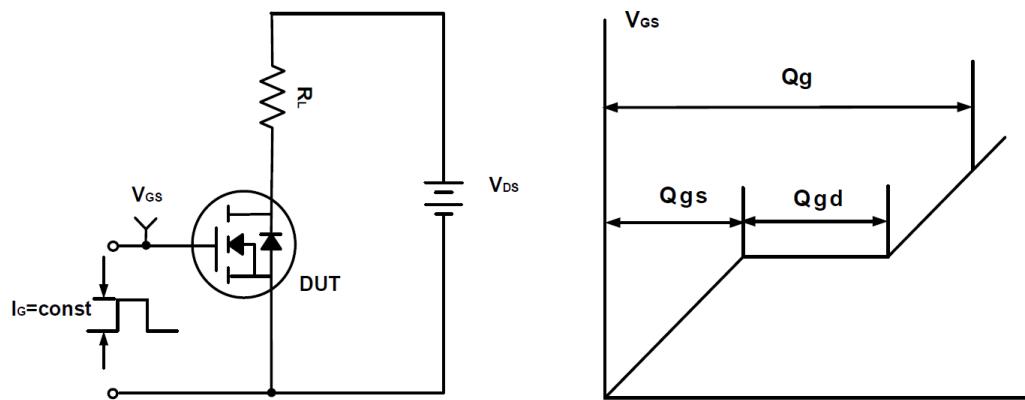
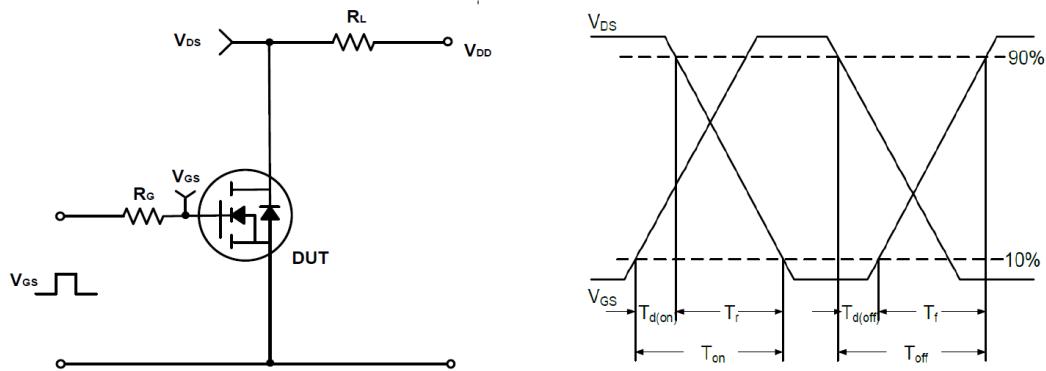
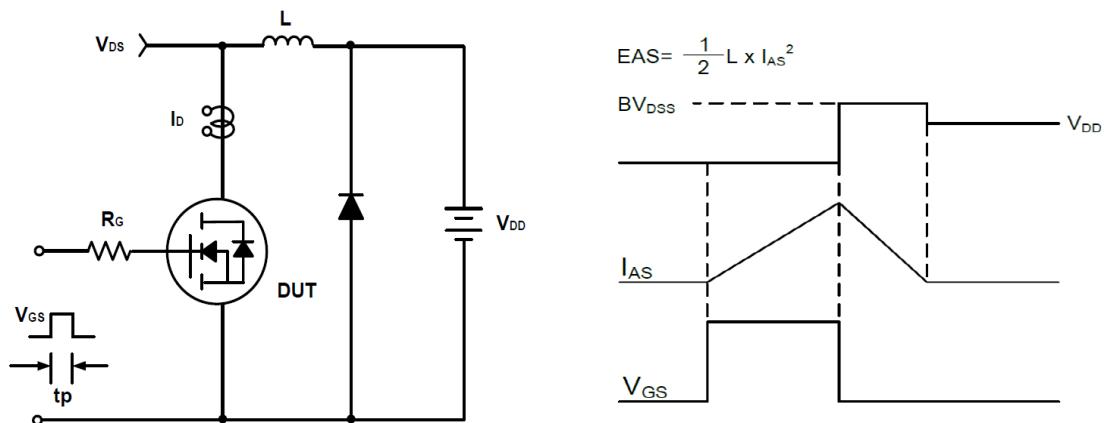
| Symbol | Parameter | Condition | Min. | Typ. | Max. | Unit |
|---|--|--|------|------|-----------|----------|
| Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated) | | | | | | |
| $V_{(BR)DSS}$ | Drain- Source Breakdown Voltage | $VGS=0V$ $ID=250\mu A$ | 650 | -- | -- | V |
| I_{DSS} | Zero Gate Voltage Drain current | $VDS=650V, VGS=0V$ | -- | -- | 1 | μA |
| I_{GSS} | Gate-Body Leakage Current | $VGS=\pm 30V, VDS=0V$ | -- | -- | ± 100 | nA |
| $V_{GS(TH)}$ | Gate Threshold Voltage | $VDS=VGS, ID=250\mu A$ | 2 | 3 | 4 | V |
| $R_{DS(ON)}$ | Drain-Source On-State Resistance (Note4) | $VGS=10V, ID=1A$ | -- | 2.9 | 5 | Ω |
| Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated) (Note5) | | | | | | |
| C_{iss} | Input Capacitance | $VDS=25V,$ $VGS=0V,$ $F=1MHz$ | -- | 350 | -- | pF |
| C_{oss} | Output Capacitance | | -- | 30 | -- | pF |
| C_{rss} | Reverse Transfer Capacitance | | -- | 1.5 | -- | pF |
| Q_g | Total Gate Charge | $VDS=480V,$ $ID=2A,$ $VGS=10V$ | -- | 6.6 | -- | nC |
| Q_{gs} | Gate-Source Charge | | -- | 1.5 | -- | nC |
| Q_{gd} | Gate-Drain Charge | | -- | 1.4 | -- | nC |
| Switching Characteristics (Note5) | | | | | | |
| $t_{d(on)}$ | Turn-on Delay Time | $VDS=300V,$ $ID=2A,$ $RG=25\Omega,$ $VGS=10V$ | -- | 14.5 | -- | nS |
| t_r | Turn-on Rise Time | | -- | 10 | -- | nS |
| $t_{d(off)}$ | Turn-off Delay Time | | -- | 28 | -- | nS |
| t_f | Turn-off Fall Time | | -- | 13 | -- | nS |
| Source- Drain Diode Characteristics@ TJ = 25°C (unless otherwise stated) | | | | | | |
| V_{SD} | Forward on voltage | $IS=2A, VGS=0V$ | -- | 0.85 | 1.4 | V |

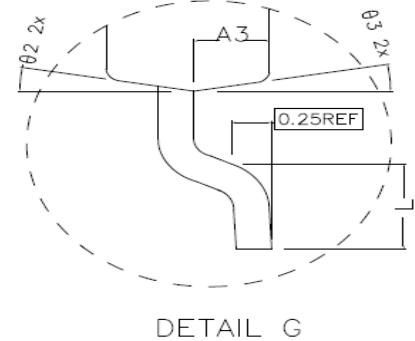
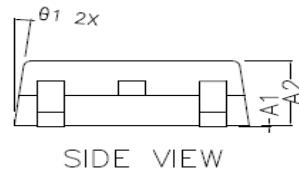
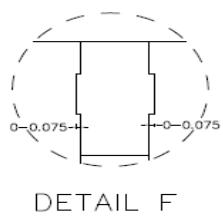
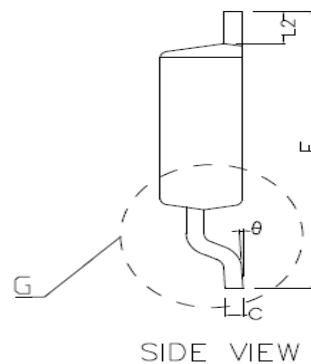
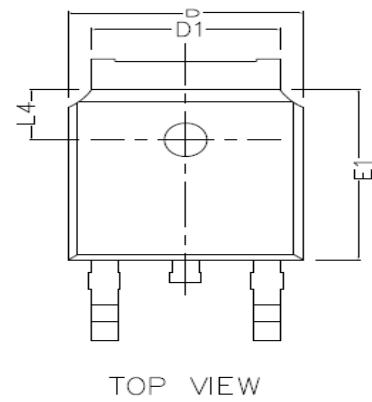
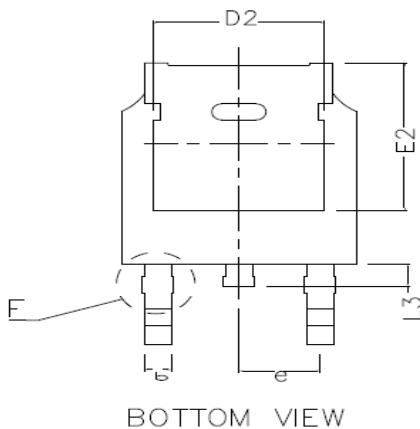
Note:

1. Limited by TJmax, starting TJ = 25° C, RG = 25Ω, VD = 50V, VGS = 10V. Part not recommended for use above this value.
2. Repetitive Rating: Pulse width limited by maximum junction temperature.
3. Surface Mounted on FR4 Board, t ≤ 10 sec.
4. Pulse Test: pulse width ≤ 300 us, duty cycle ≤ 2%.
5. Guranteed by design, not subject to production testing.

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Typical Characteristics

Figure1: T_J -Junction Temperature (°C)

Figure2: I_D -Drain Current (A)

Figure3: T_J -Junction Temperature (°C)

Figure4: V_{DS} -Drain Source Voltage (V)

Figure5: V_{DS} -Drain Source Voltage (V)

Figure6: Q_g -Gate Charge (nC)

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Figure7: Vsd-Source Drain Voltage (V)

Figure8: Vgs -Gate Source Voltage (V)

Figure9: Vds -Drain Source Voltage (V)

Figure10: Square Wave Pulse Duration (sec)

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Test Circuit and Waveform:

Figure A Gate Charge Test Circuit & Waveforms

Figure B Switching Test Circuit & Waveforms

Figure C Unclamped Inductive Switching Circuit & Waveforms

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TO-252 Package Outline Dimensions (Units: mm)


| COMMON DIMENSIONS (UNITS OF MEASURE IS mm) | | | |
|---|------------|--------|--------|
| | MIN | NORMAL | MAX |
| A1 | 0.000 | 0.100 | 0.150 |
| A2 | 2.200 | 2.300 | 2.400 |
| A3 | 1.020 | 1.070 | 1.120 |
| b | 0.710 | 0.760 | 0.810 |
| c | 0.460 | 0.508 | 0.550 |
| D | 6.500 | 6.600 | 6.700 |
| D1 | 5.330REF | | |
| D2 | 4.830REF | | |
| E | 9.900 | 10.100 | 10.300 |
| E1 | 6.000 | 6.100 | 6.200 |
| E2 | 5.600REF | | |
| e | 2.286 TYPE | | |
| L | 1.400 | 1.550 | 1.700 |
| L2 | 1.10REF | | |
| L3 | 0.80REF | | |
| L4 | 1.80REF | | |
| θ | 0~8° | | |
| θ1 | 7° TYPE | | |
| θ2 | 10° TYPE | | |
| θ3 | 10° TYPE | | |